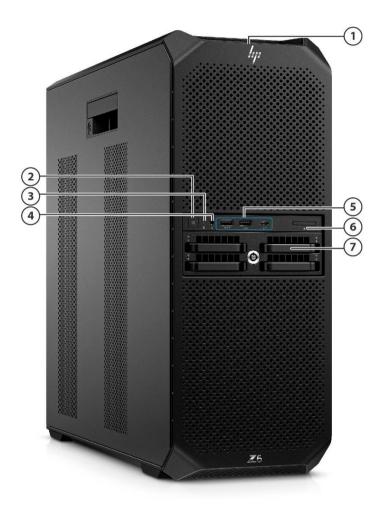
### Overview

### **HP Z6 G5 A Workstation**



- 1. Integrated Front Handle
- 2. Power Button
- 3. HDD Activity Light
- 4. CTIA Headset Jack

<sup>1</sup>Premium Front IO is shown on photography

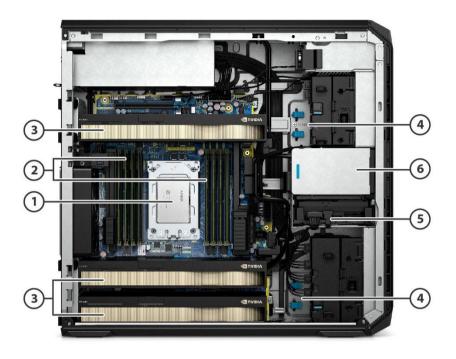
### **Front View**

Front I/O Premium:
 1 USB 3.2 Gen2x2 Type-C<sup>®</sup>, 2 USB 3.1 Gen1 Type-A (left-most Type-A port has Charging Capability)<sup>1</sup>

Front I/O Entry: 4 USB 3.1 Gen1 Type-A (left-most Type-A port has Charging Capability)

- 6. SD Card Reader
- 7. 1 External 5.25" bay

### Overview



### **Internal View**

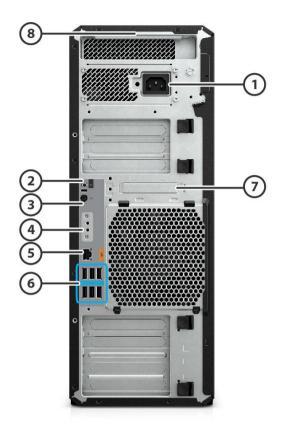
- 1. 1 AMD Ryzen™ Threadripper™ PRO 7000WX Series Processor
- 2. 8 DIMM slots for DDR5 ECC Memory
- 3. Slot 1: PCIe Gen5 x16
  - Slot 2: PCIe Gen5 x16
  - Slot 3: PCIe Gen5 x16
  - Slot 4: PCIe Gen5 x16
  - Slot 5: PCIe Gen4 x16
  - Slot 6: PCIe Gen4 x4

- 4. 4 internal onboard M.2 SSDs (2 PCIe x4 Gen5 and 2 PCIe x4 Gen4 system board connections)
- 5. 1 Internal 5.25" bay
- 6. 1 External 5.25" bay

### **NOTE:** Not shown in photography:

- 2x internal NVMe connectors to front removable M.2 carrier
- 2x internal USB Ports (1x single USB2.0 port, 1x USB3.0 port for SD card reader)
- 2x SATA ports

### Overview



### **Rear View**

- Choice of 775W, 1125W or 1450W, 90% Efficient Power Supplies
- 2. Rear Power Button
- 3. Universal Audio Jack
- 4. Flex I/O Module (optional)

- 5. 1xRJ-45 integrated LAN port (1 GbE DASH)
- 6. 6 SuperSpeed USB3.2 Gen1 Type-A 5 Gbps signaling rate
- 7. 2x10GbE LAN ports (optional)
- 8. Integrated Rear Handle

### **Overview**

### **Form Factor**

Tower

### **Operating Systems**

### Preinstalled:

- Windows 11 Pro for Workstations<sup>2</sup>
- Ubuntu 22.04 LTS<sup>4</sup>
- HP Linux®-ready (minimal OS ready for customer OS installation)<sup>5</sup>

### License Only:

 Red Hat® Enterprise Linux® Desktop Workstation (includes paper license with 1 year support; no preinstalled OS)<sup>6</sup>

### Supported:

- Windows 10 Pro for Workstations<sup>2,3</sup>
- Red Hat® Enterprise Linux® Workstation 8 & 9 6
- Ubuntu 22.04 LTS<sup>5</sup>

<sup>2</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.

<sup>3</sup> Win10 cannot be configured with 7995WX (96C) processor

<sup>4</sup> Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

<sup>5</sup>A certified preloaded version of Ubuntu® 20.04 LTS is available from HP for this platform. Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for upgrades.

<sup>6</sup>For detailed Linux<sup>®</sup> OS/hardware support information, see: http://www.hp.com/support/linux hardware matrix

**NOTE:** Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282



### Overview

#### **Processors**

		Frequ (GH		L3 Cache	Mamaru Speed	TDP	
Name <sup>1</sup>	Cores	Base Clock Speed	Boost Technology	(MB)	Memory Speed (MT/s)	(W)	
AMD Ryzen™ Threadripper™ PRO 7995WX	96	2.5	5.1	384	5200	350	
AMD Ryzen™ Threadripper™ PRO 7985WX	64	3.2	5.1	256	5200	350	
AMD Ryzen™ Threadripper™ PRO 7975WX	32	4.0	5.3	128	5200	350	
AMD Ryzen™ Threadripper™ PRO 7965WX	24	4.2	5.3	128	5200	350	
AMD Ryzen™ Threadripper™ PRO 7955WX	16	4.5	5.3	64	5200	350	
AMD Ryzen™ Threadripper™ PRO 7945WX	12	4.7	5.3	64	5200	350	

### NOTE:

- AMD Ryzen™ Threadripper™ PRO 7000WX Series processors do not offer integrated graphics
- AMD Ryzen™ Threadripper™ PRO 7000WX Series processors support ECC memory



<sup>&</sup>lt;sup>1</sup> Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numberins is not a measurement of clock speed.

### **Overview**

Black Color **Convertibility** Nο

**Expansion Slots** (see system board section for more details) • Slot 3: PCIe Gen5 x16

 Slot 2: PCIe Gen5 x16 Slot 4: PCIe Gen5 x16 Slot 5: PCle Gen4 x16

• Slot 6: PCIe Gen4 x4

Slot 1: PCIe Gen5 x16

**Expansion Bays** 

(see storage section for more details)

1x internal 3.5" bays (includes acoustic damping rail assembly)

1x external 5.25" bays (175mm depth limit)

Front I/O Front I/O Premium: 1x SuperSpeed USB Type-C<sup>®</sup> 20 Gbps signaling rate (USB Power Delivery 3.0), 2x SuperSpeed USB Type-A 5 Gbps signaling rate. 1x headphone/microphone combo. SD card reader

(optional). [left-most Type-A ports supports BC1.2 (Battery Charging)]

Front I/O Entry: 4x SuperSpeed USB Type-A 5 Gbps signaling rate, 1x CTIA headset jack, SD card reader

(optional). [left-most Type-A ports supports BC1.2 (Battery Charging)]

Internal I/O [5] 2 USB ports and 2 SATA ports.

Rear I/O 1x Universal Audio Jack, 6x SuperSpeed USB Type-A 5 Gbps signaling rate, 1x RJ-45 integrated LAN port

(1 GbE, DASH), 2x10GbE Network Module (optional), Flex I/O (optional)

**On-board RAID Support** SATA RAID 0 Striped Array

SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored **SATA RAID 5 Parity Array** 

**Chassis Dimensions** 

(H x W x D)

Footprint:

H: 17.5" [444.5 mm] W: 6.65" [169 mm]

D: 18.3" [465 mm] (measured to the rear panel)

Maximum:

H: 17.5" [444.5 mm] W: 6.65" [169 mm]

D: 18.51" [470.2 mm] (measured to the rear system fan)

H: 24.0" [630mm] **Packaged Dimensions** 

> W: 12.3" [313mm] D: 23.3" [593mm]

**Palletization Profile** 6 units x 3 lavers = 18 units per pallet

1200x1000x1836mm (pallet included)

**Rack Dimensions** 

Exact weights depend upon configuration (System weight only). Weight

> Minimum: 13.2.4kg (29.1lbs.) Typical: 14.8kg (32.6lbs.) Maximum: 23.1kg (50.9lbs.)

Choice of 80 Plus Gold (90% efficiency at 50% load) Power Supplies: **Power Supply** 

> 1450W @230V (Delta Efficiency Report) 1125W @110V (Delta Efficiency Report)

775W (Delta Efficiency Report) (LiteOn Efficiency Report)

525W (LiteOn Efficiency Report)

**NOTE:** not all configurations are supported on all power supplies. Configuration support depends on total system power budget and having sufficient number or type of PCIe supplemental power connectors. Confirm power supply and configuration support using configurator on hp.com.

1450W supports up to 900W of auxiliary graphics power (dependent on system configuration)

### Overview

- 1125W supports up to 600W of auxiliary graphics power (dependent on system configuration)
- 775W supports up to 230W of auxiliary graphics power (dependent on system configuration)

**NOTE:** updating graphics after purchase may require additional power distribution cables and/or auxiliary graphics adapters to support the new graphics configuration.

Workstation ISV Certifications Chipset See the latest list of certifications at

http://www.hp.com/united-states/campaigns/workstations/partnerships.html

AMD PRO 695 Chipset

**Memory** 8 DIMM slots, supporting up to 1TB, DDR5 5200 MT/s speed depending on the system configuration



### **Supported Components**

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	AMD Ryzen™ Threadripper™ PRO 7995WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7985WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7975WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7965WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7955WX	Υ	N		
	AMD Ryzen™ Threadripper™ PRO 7945WX	Υ	N		

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	1TB 7200 SATA 3.5" HDD	Υ	Υ	
	1TB 7200 SATA 3.5" Enterprise HDD	Υ	Υ	WOR10AA
	2TB 7200RPM SATA 3.5in Enterprise HDD	Υ	Υ	2Z274AA
	4TB 7200 RPM SATA 3.5in Enterprise HDD	Υ	Υ	K4T76AA/AT
	8TB 7200RPM SATA 3.5in Enterprise HDD	Υ	Υ	2Z273AA
	12TB 7200 RPM SATA-6G 3.5in Enterprise HDD	Υ	Υ	5S461AA
	HP 2.5in to 3.5in HDD Adapter Kit	N	Υ	J5T63AA
	HP 2.5in to 3.5in HDD Adapter Kit	N	Υ	J5T63AA

NOTE: For internal bay install, HDD option kits require separate purchase of 74Y88AA HP Z6 A HDD Cable Kit.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of system disk (for Windows) is reserved for system recovery software.

PCIe Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number
	Z Turbo 512GB PCIe-4x4 2280 TLC M.2 SSD Module	Υ	Υ	38T80AA
	Z Turbo 512GB PCIe-4x4 2280 SED OPAL2 TLC M.2 SSD Module	Υ	Υ	38T81AA
	Z Turbo 512GB PCle-4x4 2280 TLC Z4/Z6 Kit SSD	N	Υ	56Q73AA
	Z Turbo 512GB PCIe-4x4 2280 SED OPAL2 TLC M.2 Z4/Z6 Kit SSD	N	Υ	56Q74AA
	Z Turbo 1TB PCIe-4x4 2280 TLC SSD Module	Υ	Υ	38T77AA
	Z Turbo 1TB PCIe-4x4 2280 SED OPAL2 TLC M.2 SSD Module	Υ	Υ	38T76AA
	Z Turbo 1TB PCIe-4x4 2280 TLC Z4/Z6 Kit SSD	N	Υ	56Q75AA
	Z Turbo 1TB PCIe-4x4 2280 SED OPAL2 TLC M.2 Z4/Z6 Kit SSD	N	Υ	5Z7E7AA
	Z Turbo 2TB PCIe-4x4 2280 TLC SSD Module	Υ	Υ	38T75AA
	Z Turbo 2TB PCIe-4x4 2280 SED OPAL2 TLC M.2 SSD Module	Υ	Υ	38T79AA
	Z Turbo 2TB PCIe-4x4 2280 SED OPAL2 TLC M.2 Z4/Z6 Kit SSD	N	Υ	56Q77AA
	Z Turbo 4TB PCIe-4x4 2280 TLC M.2 SSD Module	Υ	Υ	5S496AA/AT
	Z Turbo 4TB PCIe-4x4 2280 SED OPAL2 TLC M.2 SSD Module	Υ	Υ	5S497AA/AT
	Z Turbo 4TB PCIe-4x4 2280 SED OPAL2 TLC M.2 Z4/Z6 Kit SSD	N	Υ	5S4A1AA
	HP Z Turbo Drive Quad Pro			

### **Supported Components**

HP Z Turbo Drive Quad Pro PCIe-4x4 NVMe Carrier <sup>1</sup>	Υ	Υ	7H9Z3AA
HP Z Turbo Drive Quad Pro 512GB TLC SSD	Υ	N	
HP Z Turbo Drive Quad Pro 1TB TLC SSD	Υ	N	
HP Z Turbo Drive Quad Pro 2TB TLC SSD	Υ	N	
HP Z Turbo Drive Quad Pro 4TB TLC SSD	Υ	N	
HP Z Turbo Drive Dual Pro			
HP Z Turbo Drive Dual Pro PCIe-4x4 NVMe Carrier <sup>2</sup>	Υ	Υ	56Q86AA
HP Z Turbo Drive Dual Pro 512GB TLC SSD	Υ	N	
HP Z Turbo Drive Dual Pro 1TB TLC SSD	Υ	N	
HP Z Turbo Drive Dual Pro 2TB TLC SSD	Υ	N	
HP Z Turbo Drive Dual Pro 4TB TLC SSD	Υ	N	

**Note 1:** Kit includes dual pro carrier and heatsink. Requires separate purchase of Z Turbo PCIe 4x4 M.2 SSD modules.

**Note 2:** Kit includes quad pro carrier and heatsink. Requires separate purchase of Z Turbo PCIe 4x4 M.2 SSD modules.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of system disk (for Windows) is reserved for system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
<b>Graphics Cable</b>	HP DisplayPort to HDMI Adapter	Υ	Υ	2JA63AA	
Adapters	HP DisplayPort to DVI Adapter (Bulk 90)	N	Υ	FH973A6	
	HP DisplayPort to VGA Adapter	N	Υ	AS615AA/AT	
	HP DisplayPort to VGA Adapter	N	Υ	F7W97AA	
	HP miniDP-to-DP Adapter Cable (single)	Υ	Υ	2MY05AA	
	HP miniDP-to-DP Adapter Cable (2-pack)	Υ	N		
	HP miniDP-to-DP Adapter Cable (4-pack)	Υ	N		
	HP miniDP-to-DP Adapter Cable (8-pack)	Υ	N		
	HP miniDP-to-DP Adapter Cable (Bulk 12)	N	Υ	2KW87A6	
	HP Graphics Power Cable CPU-8p to CPU-8p 4	N	Υ	6J6H7AA	
	HP Graphics Power Cable CPU-8p to x2 PCIe 8p(6+2) <sup>4</sup>	N	Υ	6J6H8AA	
	NVIDIA 3D Stereo Bracket	N	Υ	K0A25AA	
	NVIDIA Quadro Sync II	N	Υ	1WT20AA	
Ultra High-End	NVIDIA® RTX 6000 Ada 48GB <sup>1,3</sup>	Υ	Υ	79C23AA	3
Graphics	AMD® Radeon™ Pro W7900 48GB <sup>1,6</sup>	Υ	Υ	8F699AA	1
	NVIDIA® RTX 5000 Ada 24GB <sup>1</sup>	Υ	Υ	8D6B6AA	3
	NVIDIA Quadro Sync II	N	Υ	1WT20AA	
High-End Graphic	s NVIDIA® RTX 4500 Ada 20GB <sup>1,6</sup>	Υ			3
	NVIDIA® RTX A4500 20GB <sup>1</sup>	Υ	Υ	5S458AA/AT	3
	NVIDIA® RTX 4000 Ada 16GB 1,5,6	Υ			3
	NVIDIA® RTX A4000 16GB 1,5	Υ	Υ	20X24AA/AT	3
	NVIDIA® RTX A2000 12GB <sup>1</sup>	Υ	Υ	5Z7D9AA/AT	3

### **Supported Components**

Mid-range Graphics	NVIDIA® T1000 8GB <sup>2</sup>	Y	Υ	5Z7D8AA/AT	3
	AMD® Radeon™ Pro W7600 8GB <sup>1</sup>	Υ	Υ	8D6B9AA	3
	AMD® Radeon™ Pro W7500 8GB <sup>1</sup>	Υ	Υ	8D6C2AA	3
<b>Entry Graphics</b>	NVIDIA® T400 4GB <sup>2</sup>	Υ	Υ	5Z7EOAA/AT	3
	AMD® Radeon™ RX 6400 4GB	Υ	Υ	6Q3U4A	1

**Note 1:** Single, dual, or triple graphics configurations require the HP Z6 Fan and Front Card Guide. If configured as an after-market option, a separate purchase of the HP Z6 Fan and Front Card Guide 56Q80AA is required. If factory configured, the fan and front card guide is included.

**Note 2:** Dual or triple graphics configurations require the HP Z6 Fan and Front Card Guide. If configured as an after-market option, a separate purchase of the HP Z6 Fan and Front Card Guide 56Q80AA is required. If factory configured, the fan and front card guide is included.

**Note 3:** Triple graphics configuration requires the HP Z6 PCIe Retainer with Fans. If configured as an aftermarket option, a separate purchase of the HP Z6 PCIe Retainer with Fans 56Q85AA is required. If factory configured, the PCIe retainer with fans is included.

Note 4: Required for select graphics configurations. Note 5: Only supported with 1125W and 1450W PSUs Note 6: Not available at launch; available early 2024

Memory		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	32GB (2x16GB) DDR5 5600 DIMM ECC REG Memory	Υ	N		
	64GB (4x16GB) DDR5 5600 DIMM ECC REG Memory	Υ	N		
	64GB (2x32GB) DDR5 5600 DIMM ECC REG Memory <sup>2</sup>	Υ	N		
	128GB (8x16GB) DDR5 5600 DIMM ECC REG Memory <sup>2</sup>	Υ	N		
	128GB (4x32GB) DDR5 5600 DIMM ECC REG Memory <sup>2</sup>	Υ	N		
	256GB (8x32GB) DDR5 5600 DIMM ECC REG Memory <sup>2</sup>	Υ	N		
	256GB (4x64GB) DDR5 5600 DIMM ECC REG Memory <sup>2</sup>	Υ	N		
	256GB (2x128GB) DDR5 5600 DIMM ECC REG Memory <sup>1,2,3</sup>	Y	N		
	512GB (8x64GB) DDR5 5600 DIMM ECC REG Memory <sup>2</sup>	Υ	N		
	512GB (4x128GB) DDR5 5600 DIMM ECC REG Memory <sup>1,2,3</sup>	Υ	N		
	1TB (8x128GB) DDR5 5600 DIMM ECC REG Memory <sup>1,2,3</sup>	Y	N		
	After Market Options				
	16GB (1x16GB) DDR5 5600 DIMM ECC REG Memory	Υ	Υ	760N2AA	
	32GB DDR5 (1x32GB) 5600 DIMM ECC REG Memory <sup>2</sup>	N	Υ	760R7AA	
	64GB DDR5 (1x64GB) 5600 DIMM ECC REG Memory <sup>2</sup>	N	Υ	760R8AA	
	128GB (1x128GB) DDR5 5600 DIMM ECC REG Memory <sup>1,2,3</sup>	N	Υ	760R9AA	
	Note 1: This memory configuration requires the 1125 Note 2: Configurations with 32GB DIMMs or greater co Note 3: Not available at launch; available early 2024			led	

Multimedia andFactoryOption KitAudio DevicesConfiguredOption KitPart Number



### **Supported Components**

Poly Savi 8210/8220 Universal Power Supply - 9V 500mA	N	Υ	783M9AA
Poly Savi 7310 Headset	N	Υ	783N0AA
Poly Savi 7320 Headset	N	Υ	783N1AA
Poly Savi 7310 Headset (Teams)	N	Υ	783N2AA
Poly Savi 7320 Headset (Teams)	N	Υ	783N3AA
Poly Savi 7210 Headset	N	Υ	783Q5AA
Poly Savi 7220 Headset	N	Υ	783Q6AA
Poly BT700 USB-A Bluetooth Adapter	N	Υ	786C4AA
Poly BT700 USB-C Bluetooth Adapter	N	Υ	786C5AA
Poly DA75 USB to QD Adapter	N	Υ	786C6AA
Poly DA85 USB to QD Adapter	N	Υ	786C7AA
Poly DA85-M USB to QD Adapter	N	Υ	786C8AA
Poly Voyager Office Base	N	Υ	786C9AA
Poly Voyager Office Base Teams	N	Υ	786D0AA
HyperX Cloud MIX Wireless GAM HEADSET	N	Υ	4P5K9AA
HyperX Cloud Core Black Gaming Headset	N	Υ	4P4F2AA
HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) (HX- HSCF-BK/AM)	N	Υ	4P5L4AA
HyperX Cloud Stinger Core GAM HEADSET PC	N	Υ	4P4F4AA
HyperX Cloud II Core Wireless GAM HEADSET	N	Υ	6Y2G8AA
HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G)	N	Υ	4P5P8AA

Optical and
Removable
Storage

	Configured	Option Kit	Part Number
HP 9.5mm Slim DVD-ROM Drive	Υ	Υ	K3R63AA
HP 9.5mm Slim Blu-Ray BDXL Writer Drive	Υ	Υ	K3R65AA
HP 9.5mm Slim DVD Writer	Υ	Υ	K3R64AA

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC	Υ	Υ	436M8AA
	HP 10GbE SFP+ SR/SW LC Fiber Optic Transceiver	Υ	Υ	860T8AA
	HP 25GbE SFP28 LC Fiber Optic Transceiver	Υ	Υ	860T9AA
	HP Dual Port 10GbE NIC G2 <sup>1</sup>	Υ	Υ	360K6AA
	Intel® X550 Dual Port 10GbE NIC	Υ	Υ	1QL46AA
	Intel® I226-T1 2.5GbE NIC	Υ	Υ	
	Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC	Υ	Υ	6E3Y9A
	AT-2914SX/LC-901 Single Port 1GbE NIC	Υ	Υ	1C7Q2AA
	Intel® I350-T4 4-Port 1GbE NIC	N	Υ	W8X25AA
	HP Flex 10GbE Single Port	Υ	Υ	56Q71AA
	HP Flex 2.5GbE LAN Single Port	Υ	Υ	169K0AA/AT
	HP Flex 1GbE Fiber Single Port LC	Υ	Υ	20J15AA
	HP Flex 1GbE Single Port NIC	Υ	N	
	HP Flex MediaTek RZ616 Wi-Fi 6 +Bluetooth® 5.3 WLAN wireless	Υ	N	

### **Supported Components**

card with Internal Antenna

Intel® AX210 Wi-Fi 6E non-vPro + Bluetooth® 5.2 wireless card with External Antenna WLAN

Y 340L7AA

Note1: installation of component does not require PCIe slot

HP Anyware				
Remote System				
Controller				

	Factory Configured	Option Kit	Option Kit Part Number
HP Anyware Remote System Controller	Υ	Υ	7K6D7AA
HP Anyware Remote System Controller Main Board Adapter	Υ	Υ	7K6D8AA
HP Anyware Integrated Remote System Controller	Υ	Υ	7K6D9AA
HP Anyware Remote System Controller for Universal KVM	N	Υ	7K7N2AA

### NOTE:

HP Anyware Remote System Controller is an IT Manager targeted manageability feature. HP Anyware Remote access software is an End User centric and available as a separate AMO accessory.

Racking and
<b>Physical Security</b>

	Factory Configured	Option Kit	Option Kit Part Number
Z2 Mini/Z2 Tower/Z4/Z6 Depth Adjustable Fixed Rail Rack Kit	N	Υ	2A8Y5AA
HP Keyed Cable Lock	N	Υ	T1A62AA
HP Master Keyed Cable Lock 10mm	N	Υ	T1A63AA

### **Input Devices**

	Factory Configured	Option Kit	Option Kit Part Number
Mouse and Keyboard Combo			
HP 655 Wireless Keyboard and Mouse Combo	N	Υ	4R009AA/ET/UT/A6
HP Wired Desktop 320MK Mouse and Keyboard	N	Υ	9SR36AA/ET/UT
Keyboard only			
HP 320K Wired Keyboard	Υ	Υ	9SR37AA/ET/UT
HP 125 Wired Keyboard	Υ	Υ	266C9AA/ET/UT
HP 975 USB+BT Dual-Mode Wireless Keyboard	N	Υ	3Z726AA/UT
HP 455 Programmable Wireless Keyboard	N	Υ	4R177AA/ET/UT/A6
HP Business Slim Smartcard Keyboard	Υ	Υ	Z9H48AA/AT
HyperX MKW100 Red Gaming Keyboard	N	Υ	4P5E1AA
Mouse only			
HP Wired 320M Mouse	Υ	Υ	9VA80AA/ET/UT
HP Creator 935 Black Wireless Mouse	N	Υ	1D0K8AA/UT
HP 128 LSR Wired Mouse	Υ	Υ	265D9AA/ET/UT
HP 125 Wired Mouse	N	Υ	265A9AA/ET/UT
HyperX Pulsefire Core Black USB Gaming Mouse	N	Υ	4P4F8AA
HyperX Pulsefire Haste White Wireless Gaming Mouse 2	N	Υ	6NOA9AA
HyperX Pulsefire Haste Black Wireless Gaming Mouse 2	N	Υ	6N0B0AA



### **Supported Components**

**NOTE:** Keyboard and Mouse are optional or add on features.

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP Flex USB-C 3.2 Gen2	Υ	Υ	141K6AA/AT
	HP Flex Dual USB-A 3.2 Gen1	Υ	Υ	141J8AA/AT
	HP Flex Serial Port v3	Υ	Υ	5B895AA
	HP Dual Thunderbolt4 PCIe x4 Low Profile Card4	Υ	Υ	340L1AA
	HP Type-C SuperSpeed USB 20Gbps Front v3 Premium Module	Υ	Υ	8R3X3AA
	HP Internal Serial+PS/2 Port	Υ	Υ	56Q78AA
	HP USB 2.0 Type-A Port Adapter Kit <sup>1</sup>	N	Υ	79C24AA
	HP SD Card Reader Zx G4	Υ	Υ	2VK54AA
	HP Z6 G5 A Fan and Front Card Guide Kit <sup>3</sup>	Υ	Υ	760N5AA
	HP Z6 G5 A Memory Cooling Solution <sup>2</sup>	Υ	Υ	760N6AA
	HP Z6 G5 A PCIe Retainer with Fans <sup>3</sup>	Υ		760N7AA
	HP C13 1.83m Power Cord Kit (halogen-free)	Υ	N	
	HP C13 1.83m Power Cord Kit	Υ	Υ	6Z1T9AA
	HP C13-C14 2.0m Power Cord Kit	Υ	N	
	C13-C14 2.0m 15A 100-127V Countries Straight Desktop Power Cord	Υ	N	8R881AA
	C13-C14 2.0m 10A 200-240V Countries Straight Desktop Power Cord	Y	N	8R882AA
	HP Z4/Z6 A HDD Cable Kit	N	Υ	74Y88AA

**Note 1:** USB 2.0 Type-A Port Adapter Kit has a single USB 2.0 type A connector.

**Note 2:** HP Z6 G5 A Memory Cooling Solution 760N6AA is required as a separate purchase for after-market memory configurations using 32GB Registered DIMMs or greater. If configured from the factory, configurations using 32GB Registered DIMMs or greater will include a memory cooling solution.

**Note 3**: HP Z6 G5 A Fan and Front Card Guide Kit 760N5AA and HP Z6 G5 A PCIe Retainer with Fans 760N7AA are required for specific graphics configurations (see Graphics section).

Note 4: Not available at launch; available early 2024

Software	Factory Configured	Option Kit	Support Notes
HP Performance Advisor	Υ	N	1
HP PC Hardware Diagnostics UEFI	Υ	N	2
HP PC Hardware Diagnostics Windows	Υ	N	
HP Wolf Security	Υ	N	
HP Notifications	Υ	N	
HP Desktop Support Utility	Υ	N	
HP Documentation	Υ	N	
myHP	Υ	N	
Kingsoft WPS Office	Υ	N	
Z by HP Data Science Stack Manager	Υ	N	3
WSL2/Ubuntu Data Science Stack	Υ	N	3



### **Supported Components**

HP Image Assistant N N N HP Support Assistant N N N

Note 1: Also available as a free download from http://www.hp.com/go/performanceadvisor

Note 2: Windows OS only

Note 3: Only available with NVIDIA graphics



### **Supported Components**

Operating Systems Windows 11 Pro for Workstations<sup>2</sup>

Windows 11 Pro for Workstations (preinstalled with Windows 10 Pro for Workstations Downgrade).<sup>2,3</sup>

Windows 10 Pro for Worskations<sup>2,5</sup>

Ubuntu 22.04 LTS<sup>4</sup>

HP Linux®-ready

Red Hat® Enterprise Linux® (RHEL) Workstation - paper

<sup>2</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.

<sup>3</sup>This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

<sup>4</sup> Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

<sup>5</sup> Not available as factory image, support only.

**NOTE:** Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282



### **Supported Components**

### SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

#### Software

**HP** Anyware

HP Performance Advisor<sup>1</sup>

**HP PC Hardware Diagnostics UEFI** 

**HP PC Hardware Diagnostics Windows** 

HP Wolf Security<sup>22</sup>

**HP Notifications** 

**HP Desktop Support Utility** 

**HP Documentation** 

myHP

**HP Privacy Settings** 

**HP Easy Clean** 

Kingsoft WPS Office (China only)

WSL2/Ubuntu Data Science Stack

**HP Image Assistant (Supported)** 

**HP Support Assistant (Supported)** 

HP Services Scan<sup>25</sup>

### **Security Management**

HP Secure Erase<sup>16</sup>

HP Wolf Pro Security Edition (paid option)18

**HP Wolf Security for Business** 

**HP Sure Click** 

**HP Sure Sense** 

HP Sure Run GenX<sup>9</sup>

HP Sure Recover GenX<sup>10</sup>

HP Sure Start GenX<sup>8</sup>

**HP Tamper Lock** 

**HP Sure Admin** 

HP Client Security Manager GenX<sup>4</sup>

- <sup>1</sup> HP Performance Advisor Software HP Performance Advisor is ready to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: http://hp.com/PerformanceAdvisor
- <sup>2</sup> HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- <sup>3</sup> HP Manageability Integration Kit can be downloaded from https://ftp.ext.hp.com/pub/caps-softpaq/cmit/HPMIK.html
- <sup>4</sup> HP Client Security Manager Gen7 requires Windows and is available on the select HP PCs.
- <sup>7</sup> Microsoft Defender Opt in and internet connection required for updates.
- <sup>8</sup> HP Sure Start Gen 7 is available on select HP PCs and workstations. See product specifications for availability.
- <sup>9</sup> HP Sure Run Gen5 is available on select Windows 11 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors
- <sup>10</sup> HP Sure Recover Gen4 is available on select HP PCs and requires Windows 10 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module
- 13 HP BIOSphere Gen6 features may vary depending on the platform and configurations.
- <sup>16</sup> Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane.
- <sup>18</sup> HP Wolf Pro Security Edition is available preloaded on select SKUs and, depending on the HP product purchased, includes a



### **Supported Components**

paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software - End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-en/document/ish\_3875769-3873014-16 as that EULA is modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.

<sup>22</sup> HP Wolf Security for Business requires Windows 10 or 11 Pro higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features.

<sup>23</sup> Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

<sup>24</sup>Firmware TPM is version 15.23 and version 7.2.3.1 for Infineon and Nuvoton chips, respectively. Hardware TPM is v2.0.
<sup>25</sup> HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements . Not applicable in China.



### **System Technical Specifications**

### **System Board**

**System Board Form** 

Factor

Chipset

Tower

**Processor Socket** 

AMD Socket SP6 AMD PRO 695 Chipset

Super I/O Controller

Nuvoton SIO21

Memory Expansion Slots 8 DDR5 memory slots

Memory Type Supported DDR5 RDIMM (Registered), RDIMMs and 3DS RDIMMs

**Memory Modes** Memory Speed Supported

Non-Interleaving for single channel, Interleaving when multiple channels are populated

5200MT/s DDR5. The memory will run at the slowest supported speed that either the CPU or the memory modules support. For example, if the CPU only supports 5200MHz speed, 5600MHz will only

run at 5200MHz'

**Memory Protection** 

ECC on data

N/A

**Maximum Memory** 

1TB when 128GB are available

**Memory Configuration** 

(Supported)

16GB, 32GB, 64GB RDIMMs, 128GB 3DS RDIMMs when available, RDIMMs and 3DS RDIMMs cannot be

mixed in the same system.

**NVDIMM Memory** 

**PCI Express Connectors** 

Standard PCIe Slots:

•4 PCI Express Gen5 slot x16 mechanical/ x16 electrical (full height, full length) • 1 PCI Express Gen4 slot x16 mechanical/x16 electrical (full height, full length) • 1 PCI Express Gen4 slot x4 mechanical/ x4 electrical (full height, half length)

### M.2 Slots:

• 2 PCI Express Gen5 slot x4. • 2 PCI Express Gen4 slot x4. Other PCIe Connections:

• 2 Front NVMe Storage (SlimSAS PCIe Gen4 x8) (each PCIe connection supports two x4 M.2 devices for a total system support of four x4 M.2 devices via QX448)

1 Connector for HP Dual Port 10GbE NIC G2 (PCIe Gen4 x4)

**Supported Drive** Interfaces

Integrated (2) Serial ATA interfaces (6Gb/s SATA). **SATA** 

AMD Express SATA RAID 0 and 1 supported on Windows 11 **Integrated RAID** 

AMD Express NVMe RAID 0, 1, 5, and 10 supported on Windows 11

**Integrated Graphics** None

**Network Controller** Integrated Realtek RTL8111EPP

Interface: 1GbE RJ-45 Port (10/100/1000Mbps)

Management Capabilities: WOL, PXE, DASH Manageability

External SATA (eSATA) None

Serial 1 internal header (requires optional Serial Port Adapter Kit)

Flex IO Module **2nd Serial** 

**HD Integrated Audio** Yes

**USB Connector(s) Front** Front I/O Entry:

4 USB 3.1 Gen1 Type-A (left-most port supports Battery Charging 1.2)

Front I/O Premium:

1x USB 3.2 Gen2x2 Type-C® (Power Delivery 3.0)

2x USB 3.1 Gen1 Type-A (left-most port supports Battery Charging

1.2)

USB Type-C® Ports provide 3 Amps @ 5 Volts



### **System Technical Specifications**

• Charging USB Type-A port provides 1.5 Amps @ 5 Volts • Standard USB Type-A Ports provide 900mA @ 5 Volts

4x USB 3.1 Gen1 Type-A with USB hub and 2x USB 3.2 Gen 1 Type-A

without hub.

(Optional: 2x USB 3.0 Type-A (optional via Flex module) or 1x USB 3.1

Gen2 Type-C® charging port (optional via Flex module).

1 USB 3.2 Gen1 header, with a single 12-pin shrouded connector. This Internal

header supports a USB Media Card reader.

1 USB 2.0 single port header

**HD Integrated Audio** Yes Flash ROM Yes **CPU Fan Header** Yes **Memory Fan Header** Yes

**Chassis Fan Header** Yes (Rear, Front Upper, Front Lower)

Rear

Front PCI Fan Header Yes (Lower and Upper)

**Front Control** Yes

Panel/Speaker Header

CMOS Battery Holder -Yes

Lithium

Integrated TPM 2.0 Integrated Trusted

**Platform Module** The TPM module disabled where restricted by law, i.e. Russia.

**Power Supply Headers** Yes Power Switch, Power LED Yes & Hard Drive LED Header Yes

**Clear Password Jumper** 

**Keyboard/Mouse** USB or PS/2 (option) **Power Supply** 1125W and 775W

### System Technical Specifications

System Configuration	ns						
Example Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7945WX					
#1	Memory Info	32GB DDR5 (2x16GB) RegRAM					
	Graphics Info	1x NVIDIA® A2000					
	Disks/Optical/Floppy	1x 4TB Internal M.2 SSD + 1x DVDRW SATA					
	PSU	775W					
	Other	N/A					
Energy Consumption		115 VAC		230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	57.382	56.779	57.761	56.668	TBD	TBD
	Windows Busy Typ (S0)	36	7.6	361.6		364.79	
	Windows Busy Max (S0)	385	5.28	380.22		382.32	
	Sleep (S3)	6.557	6.483	6.976	6.543	6.574	6.492
	Off (S5)	1.969	1.949	2.448	2.059	2.032	1.957
	Zero Power Mode (EuP)	0.247		0.286		0.248	

Heat Dissipation		115	VAC	230 VAC		100 VAC		
(Btu/hr)		LAN	LAN	LAN	LAN	LAN	LAN	
		Enabled	Disabled	Enabled	Disabled	Enabled	Disabled	
	Windows Idle (S0)	195.787	193.729	197.081	193.351	198.506	193.703	
	Windows Busy Typ (S0)	1254	1.251	1233	3.779	1244	1.263	
	Windows Busy Max (S0)	1314	1.576	1297	7.311	1304	1.476	
	Sleep (S3)	22.372	22.120	23.802	22.324	22.430	22.151	
	Off (S5)	6.718	6.650	8.352	7.025	6.933	6.677	
	Zero Power Mode (EuP)	0.8	343	0.9	76	0.8	346	
Example Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7955WX						
#2	Memory Info	64GB DDR5 (4x16GB) RegRAM						
	Graphics Info	1x NVIDIA® A4000						
	Disks/Optical/Floppy	1x 4TB Internal SATA HDD + 2x 4TB Internal M.2 SSD						
	PSU	1125W						
	Other	N/A						
Energy Consumption		115 VAC		230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	75.011	72.431	75.639	73.246	74.745	72.687	
	Windows Busy Typ (S0)	533	3.61	526	5.80	535	5.71	
	Windows Busy Max (S0)	605	5.35	588	3.25	606	5.37	
	Sleep (S3)	6.708	6.657	6.825	6.627	6.712	6.664	
	Off (S5)	2.475	2.401	2.512	2.436	2.481	2.406	
	Zero Power Mode (EuP)	0.2	257	0.2	296	0.2	255	

Heat Dissipation	115 VAC		230 VAC		100 VAC	
(Btu/hr)	LAN	LAN	LAN	LAN	LAN	LAN

### System Technical Specifications

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		Enabled	Disabled	Enabled	Disabled	Enabled	Disabled	
	Windows Idle (S0)	255.938	247.134	258.080	249.915	255.030	248.008	
	Windows Busy Typ (S0)	1820.677		1797	7.442	1827	'.843	
	Windows Busy Max (S0)	2065.454		2007	7.109	2068	3.934	
	Sleep (S3)	22.888	22.714	23.287	22.611	22.901	22.738	
	Off (S5)	8.445	8.192	8.571	8.312	8.465	8.209	
	Zero Power Mode (EuP)	0.8	0.877 1.010		0.871			
Example Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7975WX						
#3	Memory Info	128GB DDR5 (8x16GB) RegRAM						
	Graphics Info	2x NVIDIA® A4	1000					
	Disks/Optical/Floppy	2x 1TB Internal SATA HDD + 2x 4TB Internal M.2 SSD + 1x DVDRW SATA						
	PSU	1125W						
	Other	N/A						

Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	108.546	105.36	109.341	105.884	108.451	104.874
	Windows Busy Typ (S0)	716	.74 700.56		718.32		
	Windows Busy Max (S0)	780.421		759.67		776.841	
	Sleep (S3)	8.295	8.034	8.455	8.237	8.311	8.287
	Off (S5)	2.289	2.271	2.297	2.281	2.288	2.274
	Zero Power Mode (EuP)	0.2	231	0.293		0.233	

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN	LAN	LAN	LAN	LAN	LAN
		Enabled	Disabled	Enabled	Disabled	Enabled	Disabled
	Windows Idle (S0)	370.359	359.489	373.071	361.276	370.035	357.831
	Windows Busy Typ (S0)	2445.516 2390.3		).311 2450.908		.908	
	Windows Busy Max (S0)	2662	2.796	2591	.994	2650	.581
	Sleep (S3)	28.302	27.412	28.848	28.105	28.357	28.275
	Off (S5)	7.811	7.748	7.837	7.783	7.806	7.759
	Zero Power Mode (EuP)	0.7	'88	0.9	99	0.7	94

Example Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7995WX
#4	Memory Info	256GB DDR5 (8x32GB) RegRAM
	Graphics Info	2x NVIDIA® A6000
	Disks/Optical/Floppy	2x 4TB Internal SATA HDD + 2x 4TB Internal M.2 SSD
	PSU	1450W/200V
	Other	N/A

Energy Consumption		115 VAC		230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	N/A N/A		179.521	157.249	N,	/A
	Windows Busy Typ (S0)			N/A 925.96		N/A	

### System Technical Specifications

Windows Busy Max (S0)	N	/A	100	3.71	N.	/A
Sleep (S3)	N/A	N/A	10.674	10.514	N/A	1
Off (S5)	N/A	N/A	2.886	2.871	N/A	N
Zero Power Mode (EuP)	TI	3D	0.3	312	N.	/A

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)		N/A		612.526 536.533		N/A	
	Windows Busy Typ (S0)	N/A N/A		3159.376		N/A	
	Windows Busy Max (S0)			3424	.658	N,	/A
	Sleep (S3)	N/A	N/A	36.419	35.873	N/A	N/A
	Off (S5)	N/A	N/A	9.847	9.795	N/A	N/A
	Zero Power Mode (EuP)	N/A		1.0	645	N,	/A



### **System Technical Specifications**

Operating Voltage Range TBD
Rated Voltage Range TBD
Rated Line Frequency TBD
Operating Line Frequency TBD
Range
ENERGY STAR® certified TBD

ENERGY STAR® certified TBD (Config Dependent)

CECP Compliant @ 220V TBD

FEMP Standby Power Compliant

**Built-in Self Test** (BIST) TBD **LED** 

**TBD** 

Surge Tolerant Full TBD
Ranging Power Supply
(withstands power surges
up to 2000V)

Hood Lock Header TBD ErP Lot 6- Tier 1 TBD Compliance @ 230V (<1W

in S5 - Power Off)

ErP Lot 6- Tier 2 TBD
Compliance @ 230V
(<0.5W in S5 - Power Off)

System Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 794	5WX			
(Entry level)	Memory Info	32GB DDR5 (2x16GB) RegRAM				
	Graphics Info	1x NVIDIA Quadro A2000				
	Disks/Optical	1x 4TB M.2 + 1x DVDRW SATA				
	Power Supply	775W				
Declared Noise Emissions		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)			
	Idle	3.33	15.9			
(1)	Hard drive Operating (Drive Random Seek)	4.10	23.9			
	Active mode	3.94	21.8			
System Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7955WX				
(Mid-level)	Memory Info	64GB DDR5 (4x16GB) RegRAM	64GB DDR5 (4x16GB) RegRAM			
	Graphics Info	1x NVIDIA Quadro A4000				
	Disks/Optical	2x 512GB M.2 SSD + 1x 4TB SATA HDD				
	Power Supply	1125W	1125W			
Declared Noise Emissions		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)			
	Idle	3.51	18.6			
	Hard drive Operating (Drive Random Seek)	4.08	24			



### **System Technical Specifications**

	Active mode	4.55	27.4				
System Configuration	Processor Info	AMD Ryzen™ Threadripper™ PRO 7999	AMD Ryzen™ Threadripper™ PRO 7995WX				
(High-end)	Memory Info	512GB DDR5 (8x64GB) RegRAM					
	Graphics Info	2x NVIDIA Quadro A6000					
	Disks/Optical	1x 4TB SATA HDD + 4x 4TB M.2 + 1x D	1x 4TB SATA HDD + 4x 4TB M.2 + 1x DVDRW				
	Power Supply	1125W					
Declared Noise Emissions		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)				
	Idle	3.19	19.1				
	Hard drive Operating (Drive Random Seek)	3.71	22.8				
	Active mode	3.22	19.1				

Envi	ironm	ental
Req	uirem	ents

**Temperature** Operating: 5° to 40°C (40° to 104°F)<sup>1</sup>

Non-operating: -40° to 60°C (-40° to 140°F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation

Maximum rate of change: 10 °C/hr No direct sustained sunlight

<sup>1</sup>40°C has been validated for configs up to a 350W CPU, 2x NVIDIA® RTX A4000 graphics cards, 8x64GB RAM, 4x 4TB M.2 storage, 1x 2TB HDD storage, and 1125W PSU

**Humidity** 

Operating: Operating: 8% to 85% RH, non-condensing, 35° C maximum wet

bulb

Non-operating: 8% to 90% relative humidity, non-condensing, 35° C

maximum wet bulb

Maximum Altitude (non-pressurized)<sup>6</sup>

Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)
Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 ft)

NOTE: Above 1524 m (5,000 feet) altitude, maximum operating

temperature is reduced by 1°C (1.8°F) per 305 m (1,000 feet) increase in

elevation.

**Dynamic** Shock

Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g)

square: 422 cm/s, 20g

NOTE: Values represent individual shock events and do not indicate

repetitive shock events

Vibration

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g $^2$ /Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g $^2$ /Hz

**NOTE:** Values do not indicate continuous vibration.

Cooling

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation,

up to 3048 m (10,000 feet)

### **System Technical Specifications**

### **Physical Security and Serviceability**

**Access Panel** Tool-less

Includes system board and memory information

**Optical Drive** Tool-less, Optical Drive requires a 5.25" bay carrier

**Hard Drives** Tool-less **Expansion Cards** Tool-less

Screw-in Retention for Processor and Cooler **Processor Socket Blue User Touch Points** Yes, on tool-less internal chassis mechanisms

Color-coordinated Cables Yes

and Connectors

Memory Tool-less **System Board** Screw-in Power and HD LED on Yes

Front of Computer

**Over-Temp Warning on** 

Screen

Yes

**Dual Function Front** 

**Power Switch** 

Yes, causes a fail-safe power off when held for 4 seconds

Padlock Support Yes (optional): Locks side cover and secures chassis from theft 7.0 mm (0.2756 in) diameter padlock

loop at rear of system

Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm **Cable Lock Support** 

slot at rear of system

**Universal Chassis Clamp** 

**Lock Support** 

Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable with threaded feature at rear of

system

Solenoid Lock and Hood

Sensor

Yes (optional)

The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The

Sensor Kit detects when the access panel has been removed

**Rear Port Control Cover** No Serial, USB, Audio, Yes Network. Enable/Disable

**Port Control** 

Removable Media Yes

Write/Boot Control

Power-On Password Yes

Setup Password Yes, prevents an unauthorized person from changing the workstation configuration.

3.3V Aux Power LED on

System PCA

Nο

NIC LEDs (integrated)

(Green & Amber)

Yes

**CPUs and Heatsinks** A T-20 Torx screwdriver is needed to remove the cooler and CPU.

Power Supply Diagnostic Yes

**LED** 

**Front Power Button** 

Front Power LED Yes, white (normal), red (fault)

Front Hard Drive Activity Yes, white

**Front ODD Activity LED** Yes



### **System Technical Specifications**

Internal Speaker Yes System/Emergency ROM Yes

Flash Recovery **Cooling Solutions** 

Air cooled forced convection

**Power Supply Fans** 80 mm x 80 mm x 25 mm (non-serviceable)

**CPU Heatsink Fan** 108 mm x 108 mm x 25 mm

**Chassis Fan** Rear: 120 mm x 120 mm x 38mm 4-wire PWM

> Front Upper: 80 mm x 80 mm x 25 mm 4-wire PWM (Option based on System Config) Front Lower: 120 mm x 120 mm x 25 mm 4-wire PWM (Option based on System Config)

Side Panel Upper: Dual 70 mm x 20 mm (Option based on System Config)

Dual 60 mm x 60 mm x 25 mm Blindmate (optional based on configuration)

Side Panel Lower: Dual 80 mm x 80 mm x 20 mm (Option based on System config)

**Memory Heatsink Fan HP PC Hardware** 

**Access Panel Kev Lock** 

**ACPI-Ready Hardware** 

Yes

**Diagnostics UEFI** 

Yes, side panel barrel keylock (optional from the factory only)

Advanced Configuration and Power Management Interface (ACPI).

• Allows the system to wake from a low power mode.

• Controls system power consumption, making it possible to place individual cards and peripherals in a

low-power or powered-off state without affecting other elements of the system.

**Integrated Chassis** 

Handles

Yes. Front handle and dedicated rear recess

Requires T15 Torx or flat blade screwdriver **Power Supply** 

**PCI Card Retention** Yes, rear (all), middle (all), front (full-length cards with extender, using Fan and Front Card

Guide Kit)

Flash ROM Yes Diagnostic Power Switch Yes

**LED** on board

Yes

**Clear Password Jumper** Yes **Clear CMOS Button** Yes **CMOS Battery Holder** Yes **DIMM Connectors** 

Service, Support, and Warranty

On-site Warranty and Service<sup>1</sup>: Three-years, limited warranty and service offering delivers on-site, next business-day<sup>2</sup> service for parts and labor, 24/7 operation will not void the HP warranty. Storage devices are not covered under warranty for 24/7 operation except for Enterprise class HDDs.

**NOTE 1:** Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.

### **Certification and Compliance**



### **System Technical Specifications**

Environmental Sustainability questions concerning:

- Ecolabels (EPEAT, TCO, etc.)
- ENERGY STAR. California Energy Commission (CEC)
- Compliance with Environmental legislation (EU ErP, China CECP, EU RoHS and other countries)
- Supply Chain Social Environmental Responsibility (SER) (conflict minerals; human rights, etc.)
- Product specific environmental features (material content, packaging content, recycled content, etc.)
- China Energy Label (CEL)

Please contact sustainability@hp.com

For country specific Regulatory Compliance approval documents or Regulatory and Safety guestions concerning:

- Declarations of Conformity (for self-service, go to https://www.hp.com/uken/certifications/technical/regulations-certificates.html?jumpid=ex\_r135\_uk/en/any/corp/hpukmu chev/certificates)
- **GS** Certificates
- Product Safety Certificates (UL, CB, BIS, etc.)
- EMC Certificates, Declarations of Conformity, or Certificates of Conformity (CE, FCC, ICES, etc.)
- **CCC Certificates**
- **Ergonomics**

Please contact techregshelp@hp.com

### **BIOS**

Full BIOS support for PCI Express through industry standard interfaces. Supported speeds and slot **PCIe 5.0 Support** 

information varv.

AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b ATA/ATAPI

WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is **WMI Support** 

Review and customize system configuration settings controlled by the BIOS.

fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM)

and WBEM specifications.

**BIOS Power On** Users can define a specific date and time for the system to power on.

**ROM Based Computer** 

Setup Utility (F10)

System/Emergency ROM Recovers system BIOS in corrupted Flash ROM.

Flash Recovery with

Video **AMD ROM Armor v3** 

AMD Transparent Secure

**Memory Encryption** 

(TSME)

AMD Platform Secure Processor enforced BIOS ROM access.

Physical encryption of all system memory decoupled from the Operating System. Provides encryption without requiring software modification.

**Replicated Setup** Saves BIOS settings to USB flash device in human readable file (HpSetup.txt).

BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed

without entering Computer Configuration Utility (F10 Setup).

**SMBIOS** System Management BIOS Reference Specification, Version 3.5

**Boot Control** Disables the ability to boot from removable media on supported devices.

**Memory Change Alert** Alerts management console if memory is removed or changed. **Thermal Alert** Monitors the temperature state within the chassis. Three modes:

• NORMAL - normal temperature ranges.

• ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer

without warning before hardware component damage occurs.

**Remote ROM Flash** Provides secure, fail-safe ROM image management from a central network console. Allows the system to enter and resume from low power modes (sleep states). **ACPI (Advanced** 



### **System Technical Specifications**

Management Interface)

Configuration and Power Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.

Supports ACPI 6.0 for full compatibility with 64-bit operating systems.

**Ownership Tag** 

A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. **Remote Wakeup/Remote** System administrators can power on, restart, and power off a client computer from a remote location.

Shutdown

Allows for very low power consumption with guick resume time.

**Instantly Available PC** (Suspend to RAM - ACPI

sleep state S3)

**Remote System Installation via F12 (PXE** operating system.

2.1) (Remote Boot from Server)

Allows a new or existing system to boot over the network and download software, including the

**ROM** revision levels

Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW

applications can use and report this information.

**System board revision** 

level

Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified. Assesses system health at boot time with selectable levels of testing.

**Start-up Diagnostics** (Power-on Self-Test) Auto Setup when new

System automatically detects addition of new hardware.

hardware installed

**Keyboard-less Operation** The system can be booted without a keyboard.

**Localized ROM Setup** 

Common BIOS image supports System Configuration Utility (F10 Setup) menus in 15 languages with

local keyboard mappings.

**Asset Tag** 

The user or MIS to set a unique tag string in non-volatile memory.

**Per-slot Control** 

Allows I/O slot parameters (option ROM enable/disable, bifurcation, speed) to be configured

individually.

**Adaptive Cooling Pre-boot Diagnostics**  Control parameters are set according to detected hardware configuration for optimal acoustics. (Pre-video) critical errors are reported via beeps and blinks on the power LED.

**UEFI Specification** 

2.7

Revision

**ACPI** Advanced Configuration and Power Management Interface, Version 6.0

"El Torito" Bootable CD-ROM Format Specification Version 1.0 **CD Boot** 

**EHCI** Enhanced Host Controller Interface for Universal Serial Bus. Revision 1.0

**PCI Express** PCI Express Base Specification, Revision 2.0

PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0

Serial ATA Specification, Revision 1.0a **SATA** 

> Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

**SPD** JEDEC JESD300-5

**TPM** Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9672).

Common Criteria EAL4+ certified.

FIPS 140-2 Certification

TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

UHCI Universal Host Controller Interface Design Guide, Revision 1.1

**USB** Universal Serial Bus Revision 1.1 Specification

Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification



### **System Technical Specifications**

Universal Serial Bus Revision 3.2 Specification USB Battery Charging specification, Revision 1.2 USB Power Delivery specification Revision 3.0

### Social and Environmental Responsibility

### Eco-Label Certifications & Declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT<sup>®</sup> Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- TCO or TCO Certified Edge: certified in all markets except North America
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label\*

## Sustainable Impact Specifications

- Product Carbon Footprint
- Ocean-bound plastic in system fan, CPU fan
- 35% post-consumer recycled plastic
- 10% recycled metal
- Low halogen
- Outside Box and corrugated cushions are 100% sustainably sourced and recyclable
- Recycled Plastic cushions.

### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

### Energy Consumption (in accordance with US ENERGY STAR® test

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	71.717 W	70.346 W	70.622 W
Normal Operation (Long idle)	69.41 W	68.18 W	68.87 W
Sleep	6.91 W	6.86 W	6.92 W
Off	2.35 W	2.19 W	2.25 W

### NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

<b>Heat Dissipation*</b>	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	245.27 BTU/hr	240.58 BTU/hr	241.53 BTU/hr
Normal Operation	237.40 BTU/hr	233.19 BTU/hr	235.55 BTU/hr



### **System Technical Specifications**

(Long idle)

 Sleep
 23.66 BTU/hr
 23.46 BTU/hr
 23.46 BTU/hr
 23.67 BTU/hr

 Off
 8.0 BTU/hr
 7.49 BTU/hr
 7.70 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L <sub>WAd</sub> , bels)	Sound Pressure (L <sub>pAm</sub> , decibels)
Typically Configured – Idle	3.33	15.9
Fixed Disk – Drive Random Seek	4.1	23.9
Optical Drive – Active Mode	3.94	21.8

### Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

### **Additional Information**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 94.6% recycle-able when properly disposed of at end of life.

Packaging Materials	External:	
---------------------	-----------	--

PAPER/Corrugated 1560 g
PAPER/Paperboard 70 g

Internal:

PLASTIC/EPE (Expanded Polyethylene) 636 g

PLASTIC/Polyethylene low density - LDPE 50 g

The plastic packaging material contains at least 92.7% recycled content.

The corrugated paper packaging materials contains at least 35% recycled content.

### **RoHS Compliance**

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

### **System Technical Specifications**

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

### **Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

### **Packaging Usage**

HP follows these quidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

### End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions



### **System Technical Specifications**

may be used by recyclers and other WEEE treatment facilities as well as HP 0EM customers who integrate and re-sell HP equipment.

### **HP**, Inc. Corporate **Environmental** Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

**Eco-label** certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

#### footnotes

- Percentage of ocean-bound plastic contained in each component varies by product
- Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.
- External power supplies, WWAN modules, power cords, cables and peripherals excluded.
- 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.
- Fiber cushions made from 100% recycled wood fiber and organic materials.
- Plastic cushions are made from >90% recycled plastic.
- Disclaimer: recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.

### Manageability

### **Industry Standard Specifications AMD DASH Manageability**

This product meets the following industry standard specifications for manageability functionality:

DASH 1.2 (via Realtek LAN on motherboard)

Provides AMD DASH Manageability functions and features including: Power Management (on, off, reset, graceful shutdown, sleep and hibernate)

- Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS)
- Indications and Events Alerting
- Text Redirection (SOL)
- **USB** Redirection
- **KVM Redirection**
- Wake-on-LAN (WOL), even with Maximum Power Savings Enabled
- DASH 1.2 compliance

**AMD Pro Technology** The HP Z6A G5 supports AMD Pro Technology for its manageability solution. Remote Manageability

The HP Z6A G5 Workstation is supported on the following remote manageability software consoles:

- Realtek Management Console
- Microsoft System Center Configuration Manager with AMPS plugin.
- AMD Management Console

DASH CLI Command Line Tool

For questions or support for manageability needs, please visit

http://www.hp.com/go/clientmanagement

**HP Anyware Remote** Supported

**System Controller** 

**Software Solutions** 



### **Technical Specifications - Storage Drives**

### STORAGE/HARD DRIVES

Performance PCIe SSDs for HP Workstations

Z Turbo 512GB 2280 PCIe-4x4 TLC SSD Capacity512GBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

**Endurance** 300TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

No

Operating Temperature 32°
Performance Sec

Sequential Read up to 6400MB/s\*
Sequential Write up to 3400MB/s\*
Random Read up to 600K IOPS\*
Random Write up to 600K IOPS\*

\*Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 512GB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Capacity 512GB
Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC

**Endurance** 300TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Nο

**Performance** Sequential Read up to 6400MB/s\*

Sequential Write up to 3400MB/s\*
Random Read up to 600K IOPS\*
Random Write up to 600K IOPS\*

Self-Encrypting Drive OPAL 2

Support

\*Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 1TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module Capacity 1TB
Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC

**Endurance** 400TBW (TB Written)

**Reliability** 1.5M hours



up to 6500MB/s\*

# QuickSpecs

### Technical Specifications - Storage Drives

Rated for 24/7/365

operation

Nο

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance** Sequential Read

> **Sequential Write** up to 5000MB/s\* **Random Read** up to 800K IOPS\* **Random Write** up to 800K IOPS\*

**Self-Encrypting Drive** 

Support

OPAL 2

\*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 1TB 2280 PCIe-4x4 TLC SSD Capacity **Protocol PCIe Form Factor** M.2 Controller NVMe **NAND Type** 3D TLC

400TBW (TB Written) **Endurance** 

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

No

**Performance Sequential Read** up to 6500MB/s\*

> **Sequential Write** up to 5000MB/s\* **Random Read** up to 800K IOPS\* **Random Write** up to 800K IOPS\*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 2TB 2280 PCIe-4x4 SED **OPAL2 TLC M.2 SSD** 

Capacity 2TB **PCIe Protocol Form Factor** M.2 **Controller** NVMe **NAND Type** 3D TLC

**Endurance** 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

**Interface** PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance Sequential Read** up to 6500MB/s\*

> **Sequential Write** up to 5000MB/s\* **Random Read** up to 800K IOPS\* **Random Write** up to 800K IOPS\*

<sup>\*</sup>Actual performance may vary.

### Technical Specifications - Storage Drives

Self-Encrypting Drive

OPAL 2

Support

\*Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 2TB 2280 PCIe-4x4 TLC SSD Capacity2TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

**Endurance** 500TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

No

Performance Sequential Read up to 6500MB/s\*

Sequential Write up to 5000MB/s\*
Random Read up to 800K IOPS\*
Random Write up to 800K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 SSD 
 Capacity
 4TB

 Protocol
 PCIe

 Form Factor
 M.2

 Controller
 NVMe

 NAND Type
 3D TLC

**Endurance** 600TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

No

**Interface** PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance** Sequential Read up to 6500MB/s\*

Sequential Write up to 5000MB/s\*
Random Read up to 700K IOPS\*
Random Write up to 700K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD 
 Capacity
 4TB

 Protocol
 PCIe

 Form Factor
 M.2

 Controller
 NVMe

 NAND Type
 3D TLC



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

### Technical Specifications - Storage Drives

**Endurance** 600TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365 No

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read up to 6500MB/s\*

Sequential Write up to 5000MB/s\*
Random Read up to 700K IOPS\*
Random Write up to 700K IOPS\*

**Self-Encrypting Drive** OPAL 2

Support

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

## Performance PCIe SSDs for HP Quad Pro Carrier

HP Z Turbo Drive Ouad Pro 512GB SSD

Capacity512GBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

**Endurance** 300TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

Nο

Performance Sequential Read U

Sequential Read up to 6400MB/s\*
Sequential Write up to 3400MB/s\*
Random Read up to 600K IOPS\*
Random Write up to 600K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP	Z٦	Γurt	0	Dr	ive	
Qu	ad	Pro	1	ТВ	SSI	D

Capacity1TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLC

**Endurance** 400TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

No

**Performance** Sequential Read up to 6500MB/s\*

Sequential Write up to 5000MB/s\*

<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

### **Technical Specifications - Storage Drives**

**Random Read** up to 800K IOPS\* **Random Write** up to 800K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

<b>HP Z Turbo Drive</b>
Quad Pro 2TB SSD

Capacity 2TB
Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC

**Endurance** 500TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Nο

Performance

Sequential Read up to 6500MB/s\*
Sequential Write up to 5000MB/s\*
Random Read up to 800K IOPS\*
Random Write up to 800K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z	Γurbo	Drive
Quad	Pro 4	TB SSD

Capacity	4TB
Protocol	PCIe
Form Factor	M.2
Controller	NVMe
NAND Type	3D TLC

Endurance 500TBW (TB Written)

**Reliability** 1.5M hours

Rated for 24/7/365

operation

ce PCI Express

**Interface** PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

Nο

Performance Sequential Read up to 6500MB/s\*

Sequential Write up to 5000MB/s\*
Random Read up to 800K IOPS\*
Random Write up to 800K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

### Performance PCIe SSDs for HP Dual Pro Carrier

HP Z Turbo Drive Dual Pro 512GB SSD

Capacity512GBProtocolPCIeForm FactorM.2ControllerNVMe

<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

### Technical Specifications - Storage Drives

3D TLC NAND Type

**Endurance** 300TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

PCI Express 4.0 x4 electrical

Interface **Operating Temperature** 32° to 158° F (0° to 70° C)

No

**Performance** Sequential Read up to 6400MB/s\*

> **Sequential Write** up to 3400MB/s\* **Random Read** up to 600K IOPS\* **Random Write** up to 600K IOPS\*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP	Z	Tu	rbo	) Di	rive	
Du	al	Pr	o 1	TB	SSE	)

1TB Capacity PCle Protocol **Form Factor** M.2 Controller NVMe **NAND Type** 3D TLC

**Endurance** 400TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance Sequential Read** up to 6500MB/s\*

> Sequential Write up to 5000MB/s\* **Random Read** up to 800K IOPS\* **Random Write** up to 800K IOPS\*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP	Z	Τι	ırl	00	Dı	riv	e
Du	al	Pı	0	21	В	SS	D

Capacity 2TB **Protocol PCIe Form Factor** M.2 **Controller** NVMe **NAND Type** 3D TLC

**Endurance** 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

No

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

**Performance Sequential Read** up to 6500MB/s\*

> **Sequential Write** up to 5000MB/s\* **Random Read** up to 800K IOPS\*



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

### Technical Specifications - Storage Drives

**Random Write** up to 800K IOPS\*

\*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z	Turbo	Drive
Dual	Pro 41	TB SSD

Capacity 4TB **Protocol** PCIe **Form Factor** M.2 Controller NVMe NAND Type 3D TLC

**Endurance** 500TBW (TB Written)

Reliability 1.5M hours

Rated for 24/7/365

operation

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

No

**Performance Sequential Read** 

up to 6500MB/s\* **Sequential Write** up to 5000MB/s\* **Random Read** up to 800K IOPS\* **Random Write** up to 800K IOPS\*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

#### **SATA Hard Drives** for HP Workstations

1TB	7200F	RPM	<b>SATA</b>	3.5in
Ente	erprise	e HD	D	

n Capacity 1TB **Protocol** SATA Form Factor 3.5" Controller AHCI Reliability 2.0M hours 8760/vr **Rated Power On Hours Annualized Failure Rate** <0.62% (based on Rated POH) YES

Rated for 24/7/365

operation

Height 1 in: 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

> **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

**Synchronous Transfer** 

Rate (Maximum)

Up to 600MB/s \*

**Buffer** 128MB Cache Adaptive

**Seek Time** (typical reads, **Single Track** 0.32 ms \* includes controller 7.45 ms \* Average overhead, including **Full Stroke** 14.2 ms \* settling)

**Rotational Speed** 7,200 rpm **Logical Blocks** 1,953,525,168

<sup>\*</sup>Actual performance may vary.

#### Technical Specifications - Storage Drives

**Operating Temperature** 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s\*
Sequential Write up to 226MB/s\*

\*Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

2TB 7200RPM SATA 3.5in Capacity Enterprise HDD Protocol

Protocol SATA

Form Factor 3.5"

Controller AHCI

Reliability 2.0M hours

Rated Power On Hours 8760/yr

Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365 YES

operation

123

2TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in: 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s \*

Buffer 128MB Cache Adaptive

Seek Time (typical reads,<br/>includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average0.7 ms \*Average<br/>Full Stroke8.5 ms \*15.7 ms \*

**Rotational Speed** 7,200 rpm **Logical Blocks** 3,907,029,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s\*
Sequential Write up to 226MB/s\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

4TB 7200 RPM SATA 3.5in Capacity
Enterprise HDD Protocol

Capacity 4TB
Protocol SATA
Form Factor 3.5"
Controller AHCI
Poliability 3.0Mb

Reliability 2.0M hours
Rated Power On Hours 8760/yr
Annualized Failure Rate <0.62%

(based on Rated POH)

Rated for 24/7/365 YES

operation

Height 1 in; 2.54 cm



<sup>\*</sup>Actual performance may vary.

#### Technical Specifications - Storage Drives

Width	Media Diameter	3.5 in; 8.9 cm
	Physical Size	4 in; 10.17 cm
Interface	Serial ATA (6.0Gb/s)	, NCQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
Buffer	256MB	
Cache	Adaptive	
Seek Time (typical reads,	Single Track	0.7 ms *
includes controller	Average	8.5 ms *
overhead, including settling)	Full Stroke	15.7 ms *
<b>Rotational Speed</b>	7,200 rpm	
Logical Blocks	7,814,037,168	
Operating Temperature	41° to 131° F (5° to 5	55° C)
Performance	Sequential Read	up to 226MB/s
	Sequential Write	up to 226MB/s

<sup>\*</sup>Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

8TB

8TB	<b>7200RPM SATA 3.5in</b>
Fnte	ernrise HNN

p	
Protocol	SATA
Form Factor	3.5"
Controller	AHCI
Reliability	2.0M hours
Rated Power On Hours	8760/yr
Annualized Failure Rate	<0.62%

(based on Rated POH)

Rated for 24/7/365 YES

operation

Capacity

**Height** 1 in; 2.54 cm

WidthMedia Diameter3.5 in; 8.9 cmPhysical Size4 in; 10.17 cm

Up to 600MB/s \*

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 256MB Cache Adaptive

Seek Time (typical reads,<br/>includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average0.7 ms \*Average<br/>Full Stroke8.5 ms \*15.7 ms \*

Rotational Speed 7,200 rpm Logical Blocks 15,628,053,168

**Operating Temperature** 41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s\*
Sequential Write up to 226MB/s\*



<sup>\*</sup>Actual performance may vary.

#### Technical Specifications - Storage Drives

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

12TB 7200 RPM SATA-6G Capacity
3.5in Enterprise HDD Protocol

Capacity12TBProtocolSATAForm Factor3.5"ControllerAHCIReliability2.0M hoursRated Power On Hours8760/yrAnnualized Failure Rate<0.62%</th>

(based on Rated POH)

Rated for 24/7/365

operation

**Height** 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Up to 600MB/s \*

**Physical Size** 4 in; 10.17 cm

0.7 ms \*

8.5 ms \*

15.7 ms \*

Interface Serial ATA (6.0Gb/s), NCQ enabled

YFS

 ${\bf Synchronous\ Transfer}$ 

Rate (Maximum)

Buffer 256MB Cache Adaptive

Seek Time (typical reads, includes controller overhead, including settling)

Single Track
Average
Full Stroke

**Rotational Speed** 7,200 rpm **Logical Blocks** 23,437,770,752

**Operating Temperature** 41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s\*
Sequential Write up to 226MB/s\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.



<sup>\*</sup>Actual performance may vary.

#### **Technical Specifications - Graphics**

#### **GRAPHICS**

NVIDIA® RTX™ 6000 Ada Form Factor

48GB

Form Factor Full-Height Dual Slot (4.4" Height x 10.5" Length)

Weight: 1230 grams / 2.71 lbs (with extender)

Max Power Consumption Power: 300 Watts

Cooling: Active

**GPU Memory** 48GB GDDR6 memory ECC

Memory Bandwidth: Up to 960 GB/s

Memory Width: 384 bits

**Connectors** 4x DisplayPort 1.4a

Quadro Sync II connector

Stereo Sync

Requires CEM 5.0 16-pin auxiliary power adapter

Maximum Resolution 7680x4320 @ 120Hz

Bus Type PCI Express 4.0 x16

**Available Graphics** 

**Drivers** 

Windows 11 Windows 10 Linux® 64-bit

NVIDIA® RTX™ 5000 Ada

**32GB** 

**Form Factor** Full-Height Dual Slot (5.0" Height x 13.85" Length)

Weight: 1130 grams / 2.49 lbs (excluding extender)

**Max Power Consumption** Power: 250 Watts

Cooling: Active

**GPU Memory** 32GB GDDR6 memory ECC

Memory Bandwidth: Up to 576 GB/s

Memory Width: 256 bits

**Connectors** 4x DisplayPort 1.4a

Quadro Sync II connector

Stereo Sync

Requires CEM 5.0 16-pin auxiliary power adapter

Maximum Resolution 7680x4320 @ 120Hz

Bus Type PCI Express 4.0 x16

**Available Graphics** 

**Drivers** 

PCI Express 4.0 x16 Windows 11

Windows 10 Linux® 64-bit

NVIDIA® RTX 4500 Ada

24GB

**Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length)

Max Power Consumption 210W

**GPU Memory** 24GB GDDR6

Memory Bandwidth: 432 GB/s

Memory Width: 192-bit

**Connectors** 4x DisplayPort 1.4a

Requires: 1x 16-pin CEM 5 power connector (adapter may be needed)

**Maximum Resolution** 4x @ 4096 x 2160 @ 120Hz

4x @ 5120 x 2880 @ 60Hz 2x @ 7680 x 4320 @ 60Hz

**Bus Type** PCI Exress 4.0 x16

Available Graphics Windows 10

**Drivers** Windows 11

#### **Technical Specifications - Graphics**

NOTE: Not available at launch: available early 2024

**NVIDIA® RTX A4500** 

**20GB** 

Full-Height Dual Slot (4.4" Height x 10.5" Length) **Form Factor** 

Weight: 1049 grams + 80 grams extender

Max Power Consumption Power: 200W

Cooling: Active

**GPU Memory** 20GB GDDR6 memory

Memory Bandwidth: Up to 640 GB/s

Memory Width: 320 bit

Connectors 4x DisplayPort 1.4a

**Ouadro Sync II connector** 

**NVLink®** Stereo Svnc

Requires 8-pin auxiliary power

**Maximum Resolution** 

7680x4320 @ 120Hz PCI Express 4.0 x16

**Bus Type** Available Graphics

Drivers

Windows 11 Windows 10

Linux® 64-bit

NVIDIA® RTX 4000 Ada

**20GB** 

Form Factor Full-Height Triple Slot (4.4" Height x 11.5" Length)

Max Power Consumption 130W

**GPU Memory** 20GB GDDR6

Memory Bandwidth: 360 GB/s

Memory Width: 160-bit

**Connectors** 4x DisplayPort 1.4a

Requires: 1x 16-pin CEM 5 power connector (adapter may be needed)

**Maximum Resolution** 4x @ 4096 x 2160 @ 120Hz

> 4x @ 5120 x 2880 @ 60Hz 2x @ 7680 x 4320 @ 60Hz

PCI Exress 4.0 x16

**Bus Type Available Graphics** 

Drivers

Windows 10

Windows 11

NOTE: Not available at launch; available early 2024

**NVIDIA® RTX A4000** 

**16GB** 

**Form Factor** Full-Height Single Slot (4.4" Height x 9.5" Length)

Weight: 500 grams

Max Power Consumption Power: 140W

Cooling: Active

16GB GDDR6 memory **GPU Memory** 

Memory Bandwidth: Up to 448 GB/s

Memory Width: 256 bit

Connectors 4x DisplayPort 1.4a

Quadro Sync II connector

Stereo Sync

Requires 6-pin auxiliary power



#### **Technical Specifications - Graphics**

**Maximum Resolution** 

7680x4320 @ 120Hz PCI Express 4.0 x16

**Available Graphics** 

Drivers

Bus Type

Windows 11 Windows 10 Linux® 64-bit

NVIDIA® RTX A2000

12GB

**Form Factor** Half-Height Dual Slot (2.713"

Height x 6.6" Length) Weight: 306 grams

Max Power Consumption Power: 70W

Cooling: Active

**GPU Memory** 12GB GDDR6 memory

Memory Bandwidth: Up to 288 GB/s

Memory Width: 192 bit

Connectors4x mini-DisplayPort 1.4aMaximum Resolution7680x4320 @ 120HzBus TypePCI Express 4.0 x16

**Available Graphics** 

**Drivers** 

Windows 11 Windows 10 Linux® 64-bit

NVIDIA® T1000 8GB

**Form Factor** Half-Height Single Slot (2.713"

Height x 6.137" Length) Weight: 132.6 grams

Max Power Consumption Power: 50W

Cooling: Active

**GPU Memory** 8GB GDDR6 memory

Memory Bandwidth: Up to 160 GB/s

Memory Width: 128 bit

Connectors4x mini-DisplayPort 1.4aMaximum Resolution7680x4320 @ 120HzBus TypePCI Express 3.0 x16

**Available Graphics** 

**Drivers** 

PCI Express 3.0 x16
Windows 11

Windows 10 Linux® 64-bit

NVIDIA® T400 4GB Graphics

**Form Factor** Half-Height Single Slot (2.713"

Height x 6.137" Length) Weight: 123.5 grams

Max Power Consumption Power: 30W

Cooling: Active

**GPU Memory** 4GB GDDR6 memory

Memory Bandwidth: Up to 80 GB/s

Memory Width: 64 bit

Connectors3x mini-DisplayPort 1.4aMaximum Resolution7680x4320 @ 120HzBus TypePCI Express 3.0 x16

Available Graphics

**Drivers** Windows 10



Windows 11

#### **Technical Specifications - Graphics**

Linux® 64-bit

AMD® Radeon™ Pro W7900 48GB **Form Factor** Full-Height Triple Slot (4.38"

Height x 11.0" Length)

Max Power Consumption 295W

**GPU Memory** 48GB GDDR6

Memory Bandwidth: 864 GB/s Memory Width: 384-bit

**Connectors** 3x DP 2.1 + 1x Enhanced Mini DP 2.1

Requires: 2x 8-pin PCIe Aux Power

Maximum Resolution 4x @ 4096 x 2160 (4K DCI) @ 120Hz with DSC

2x @ 6144 x 3456 (6K) 12-bit HDR @ 60Hz Uncompressed 1x @ 7680 x 4320 (8K) 12-bit HDR @ 60Hz Uncompressed

1x @ 12288 x 6912 (12K) @ 120Hz with DS

**Bus Type** PCI Express 4.0 x16

Available Graphics

Drivers

Windows 10 Windows 11

NOTE: Not available at launch; available early 2024

AMD® Radeon™ Pro W7600 8GB Form Factor Full-Height Single Slot (4.38"

Height x 9.5" Length)

Max Power Consumption 130W

**GPU Memory** 8GB GDDR6

Memory Bandwidth: 288 GB/s

Memory Width: 128-bit

**Connectors** 4x DP 2.1

Requires: 1x 6-pin PCIe Aux Power

**Maximum Resolution** 4x @ 3840x2160 (4K)

4x @ 5120x2880 (5K) 2x @ 7680x4320 (8K)

**Bus Type** PCI Express 4.0 x8

**Available Graphics** 

Windows 10

Drivers

Windows 11

AMD® Radeon™ Pro W7500 8GB **Form Factor** Full-Height Single Slot (4.38"

Height x 8.5" Length)

Max Power Consumption 70W

**GPU Memory** 8 GB GDDR6

Memory Bandwidth: 173 GB/s Memory Width: 128-bit

Connectors 4x DP 2.1

Maximum Resolution 4x @ 3840x2160 (4K)

4x @ 5120x2880 (5K) 2x @ 7680x4320 (8K)

Bus Type PCI Express 4.0 x8

Available Graphics Windows 10

**Drivers** Windows 11

AMD® Radeon™ RX 6400 Form Factor Half-Height Single Slot (4.4"

#### **Technical Specifications - Graphics**

**4GB** Height x 10.5" Length)

Weight: 155 grams

**Max Power Consumption** Power: 50W

Cooling: Active

**GPU Memory** 4GB GDDR6 memory

Memory Bandwidth:

Memory Width:

**Connectors** 1x DisplayPort 1.4a

1x HDMI

 $\textbf{Maximum Resolution} \qquad 7680 \text{x} 4320 \ @ \ 60 \text{Hz}$ 

**Bus Type** PCI Express 4.0 x4

Available Graphics Windows 11

**Drivers** Windows 10 Linux® 64-bit

#### Notes for all graphics cards:

• Some graphics and GPU compute cards can consume a great deal of power, thus combinations of cards with other components may exceed a particular power supply's output capability.

- Some graphics and GPU compute cards require supplemental power cables.
- Not all chassis/PSU configurations have enough supplemental power cables of the correct type for all graphics configurations.

Refer to the Power Supply section within Overview for more information.



### Technical Specifications - Optical and Removable Storage

Rates

#### **OPTICAL AND REMOVABLE STORAGE**

HP 9.5mm Slim Blu-Ray Writer Description9.5mm height, tray-loadMounting OrientationEither horizontal or vertical

Interface Type SATA/ATAPI

**Dimensions** (WxHxD) 128 x 9.5 x 127mm

**Supported Media Types** BD-ROM

BD-R BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

**Disc Capacity DVD-ROM** 8.5 GB DL or 4.7 GB standard

Blu-ray 25 GB (single-layer)

50 GB (dual-layer) 100/128 GB (BDXL)

Full Stroke DVD < 230 ms (seek)
Full Stroke CD < 220 ms (seek)

Blu-ray< 230 ms (seek) (Full Stroke Blu-ray)</th>Startup Time(Time to drive ready from tray loading)

BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S

DVD-RW 25S

DVD+R (SL/DL) 25S / 25S

DVD+RW 25S CD-ROM 15S

Maximum Data Transfer CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

**DVD ROM Read** DVD+RW Up to 8X

DVD-RW Up to 8X
DVD+R DL Up to 8X
DVD-R DL Up to 8X
DVD-ROM Up to 8X
DVD-ROM DL Up to 8X
DVD+R Up to 8X
DVD-R Up to 8X
DVD-R Up to 8X

Blu-ray BD-ROM Up to 6X

BD-ROM DL Up to 6X
BD-R Up to 6X
BD-R DL Up to 6X
BD-R Up to 6X
BD-RE SL/DL Up to 6X

#### Technical Specifications - Optical and Removable Storage

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p

**DC Current** 5 VDC -900 mA typical, 2000mA

maximum

**Operating Environmental Temperature** 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity 10% to 80% Maximum Wet Bulb 84° F (29° C)

Temperature

Operating Systems
Supported

Windows 11, Windows 10, Windows 7 Professional 64-bit, Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation

SUSE Linux® Enterprise Desktop 15

Ubuntu 20.04, 22.04 LTS

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim

SATA data/power cable, installation guide

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

**NOTE:** HD-DVD disks cannot be played on the DVD-ROM drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. Flawless playback on all systems is not guaranteed.

HP 9.5mm Slim DVD Writer **Description** 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

**Dimensions** (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

**Disc Capacity DVD-ROM** 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 200 ms (seek)
Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

Rates

**CD ROM Read** CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X



### Technical Specifications - Optical and Removable Storage

DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

**Power** Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

**DC Current** 5 VDC -< 800 mA typical, <1600 mA maximum

10% to 80%

**Operating Environmental Temperature** 41° to 122° F (5° to 50° C)

(all conditions non-

**Relative Humidity** condensing) **Maximum Wet Bulb** 

84° F (29° C)

**Temperature** 

**Operating Systems** Supported

Windows 11, Windows 10, Windows 7 Professional 64-bit.

Windows Vista Business 64\*. Windows 2000.

Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation

SUSE Linux® Enterprise Desktop 15

Ubuntu 20.04, 22.04 LTS

\* No driver is required for this device. Native support is provided by the

operating system

**Kit Contents** HP SATA DVD Writer drive, installation guide.

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Laver discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.



### Technical Specifications - Optical and Removable Storage

**HP 9.5mm Slim DVD-ROM** Description 9.5mm height, tray-load

**Mounting Orientation** Either horizontal or vertical

**Interface Type** SATA/ATAPI **Dimensions** (WxHxD) 128 x 9.5 x 127mm

**Disc Capacity DVD-ROM** Single layer: Up to 4.7 GB

Double laver: Up to 8.5 GB

**Access Times DVD-ROM Single Layer** < 110 ms (typical)

> **CD-ROM Mode 1** < 110 ms (typical) **Full Stroke DVD** < 230 ms (typical) **Full Stroke CD** < 220 ms (typical)

**Power** SATA DC power receptacle Source

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

**DC Current** 5 VDC -< 800 mA typical, <1600 mA maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-

**Relative Humidity** 10% to 80% condensing) **Maximum Wet Bulb** 84° F (29° C)

**Temperature** 

**Operating Systems** Supported

Windows 11, Windows 10, Windows 8.1, Windows 7 Professional 64-bit

Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation

SUSE Linux® Enterprise Desktop 15

Ubuntu 20.04, 22.04 LTS

No driver is required for this device. Native support is provided by the

operating system.

**Kit Contents** 9.5mm Slim DVD-ROM Drive, 5.25"" ODD Bay adapter/carrier, slim SATA

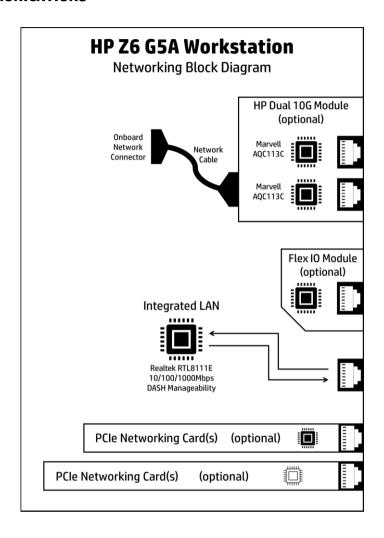
data/power cable, installation quide

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.



### **Technical Specifications - Networking and Communications**

#### **NETWORKING AND COMMUNICATIONS**



Realtek RTL 8111EPP (Integrated)

Connector RJ45

Cabling Up to 100m with Cat 5e or better

**Controller** Realtek RTL8111EPP **Data Rates Supported** 10/100/1000Mbps

**Compliance** IEEE 802.3, 802.3ab, 802.3u, 802.3x, 802.3az-2010 (EEE)

Microsoft NDIS5, NDIS6 (IPv4, IPv6, TCP, UDP) Chesum and Segmentation

Task-offload, RSS, Auto-negotiation

IEEE 802.1P Layer 2 priority encoding, IEEE 802.1Q VLAN

PCI MSI and MSI-X
Jumbo Frames up to 9Kb

**USB** Redirection

**Bus Architecture** PCle **Data Transfer Mode** BASE-T

Network Transfer Rate 10/100/1000Mbps

Management Capabilities DASH System Manageability, Wake-On-LAN, PXE, UEFI

**Kit Contents** Integrated into system

#### Technical Specifications - Networking and Communications

NVIDIA® Mellanox® Connect ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC

**Connector** 2 x SFP28 Transceiver Cage (Dual Port)\*

Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber optic

cabling with LC SFP28 Transceivers.

Controller ConnectX6-DX

Memory 256Mbit SPI Quad Flash Device

**Data Rates Supported** 1/10/25GbE \*

IEEE 802.3by, 802.3ae, 802.3ap, 802.3ad, 802.1AX, 802.1Q, 802.1P, 802.1Qau (QCN), 802.1Qaz (ETS), 802.1Qbb (PFC), 802.1Qbg, 1588v2

Jumbo frame support (9.6KB) CB/cTUVus/CE Compliant CE/FCC/VCCI/RCM Compliant

RoHS/KCC/CAN ICES-3 (B)/NM EN 55035/55032 (Morocco)/UKCA Compliant

**Bus Architecture** PCle Gen 4 x8

**Data Transfer Mode** PCI Express - stores and accesses Ethernet fabric connection information

and packet data

Power Requirements 11.5 Watts (typical)
Network Transfer Rate 15.5 Watts (typical)
16.5 Watts (typical)

NOTE: Network Transfer Rate depends on transceiver model.\*

Kit Contents NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC

### HP 25GbE SFP28 LC Fiber Connector Optic Transceiver Cabling

Connector LC Fiber Optic Connector

Cabling Typically OM4 or higher MMF LC fiber optic cabling, up to 100m on OM4, up

to 70m on 0M3

**Data Rates Supported** 25Gbps

**Compliance** SFF-8472 and 8431, Hot pluggable SFP+ footprint

**Compatibility** Intended for use with NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE NIC

Wavelength 850nm

**Kit Contents** 25GbE SFP28 Transceiver

HP 10GbE SFP+ SR/SW LC Connector Fiber Optic Transceiver Cabling

Connector LC Fiber Optic Connector

Cabling Typically OM4 or higher MMF LC fiber optic cabling, up to 300m on MMF

**Data Rates Supported** 10Gbps

**Compliance** SFF-8472 and 8431, Hot pluggable SFP+ footprint

Compatibility Intended for use with NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE NIC

Wavelength 850nm

**Kit Contents** 10GbE SFP+ Transceiver

HP Dual Port 10GBase-T NIC Module G2 **Networking Interface** 2 x RJ-45 (Dual Port)

System Interface Cabled from Dedicated Rear I/O Slot

**Controller** Marvell AQC113C

**Memory** 128KB Tx Buffer, 192KB Rx Buffer on-chip



<sup>\*</sup> You must have a transceiver installed in order to connect this card to a network.

#### Technical Specifications - Networking and Communications

**Networking Speeds** 

Supported

10Gbps, 5Gbps, 2.5Gbps, 1Gbps, 100Mbps, 10Mbps

Compliance

IEEE 802.3 - 2018, IEEE 802.1AS-2011

Cabling (up to 100m)

Cat5e (or higher) for 1Gbps

Cat6a (or higher) for 10Gbps

Power Consumption (active-typical)

5.5W at 1Gbps 11.2W at 10Gbps

**Physical Dimensions** 

0.875 in x 3 in x 2.75 in

**Connect Speed LED Indicators** 

Link/Activity LED Off = No link

Blinking = Activity

Speed LED

Amber = 1Gbps

Green = 10Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Intel® X550 10GBASE-T **Dual Port NIC** 

2 x RJ-45 (Dual Port) Connector

Cabling Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps

Cat6 (or higher) for 10Gbps up to 55m Cat6a (or higher) for 10Gbps up to 100m

Controller Intel® X550-AT2

Jumbo Frames up to 15.5KB, 64 Tx and 64 Rx Queues per port, 160KB/port Memory

of programmable memory transmit buffers

**Data Rates Supported** 

100Mbps (BASE-TX), 1Gbps (BASE-T, 2.5Gbps, 5Gbps, 10Gbps

Compliance

802.1q (VLAN), 802.1Qbb, 802.1p, 802.1Qaz

**Bus Architecture** PCIe 3x4

**Data Transfer Mode** 

PCIe Gen 3 x4 based interface

**Power Requirements** 

3.9W at 100Mbps 5.5W at 1Gbps

11.2W at 10Gbps

**Boot ROM Support** 

**Network Transfer Mode** Auto negotiation between 1GbE, 2.5GbE, 5GbE and 10GbE

Management Capabilities DMI 2.0 Support, Windows Management Instrumentation (WMI) and SNMP.

PXE 2.0 through boot ROM, Multi-mode I/O Virtualization, VxLAN, VMDg,

VLAN support with VLAN tag insertion

Intel® X550 10GBASE-T Dual Port NIC **Kit Contents** 

**HP 10GBase-T Flex Port** 

Connector RJ45 (Single Port)

Cabling Twisted Pair Cabling, up to 100m

> Cat5e (or higher) for 1Gbps Cat6a (or higher) for 10Gbps

Controller Marvell AQC113C

Memory 128KB Tx Buffer, 192KB Rx Buffer on-chip

#### Technical Specifications - Networking and Communications

**Data Rates Supported** 10/100/1000 Mbps and 2.5/5/10 Gbps

IEEE 802.3 - 2018, IEEE 802,1AS-2011 Compliance

**Bus Architecture** PCI Express and SMBus

**Data Transfer Mode** PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic

**Power Consumption** 

5.5W at 1Gbps (typical) 11.2W at 10Gbps

**Network Transfer Mode** Full-duplex, Half-duplex

**Network Transfer Rate** 10GBASE-T

> 5GBASE-T 2.5GBASE-T 1000BASE-T 100BASE-TX 10BASE-Te

Management Capabilities WOL, PXE, UEFI,

**Kit Contents** HP 10GBase-T Flex Port NIC Module

NOTE: Not available at launch; available early 2024

Intel® 1226-T1 1 port 2.5GbE NIC Connector 1xRJ-45

Cabling Cat5e (or higher) for 2.5Gbps up to 100m

Controller Intel® I226

Memory Jumbo Frames up to 9.5KB, 4 Tx and Rx Queues

**Data Rates Supported** 

Compliance IEEE 802.3 auto negotiation, 802.3, 802.3u, 802.3ab, 802.3x, 802.3z,

10Mbps, 100Mbps, 1Gbps, 2.5Gbps

IEEE1588 protocol and 802.1AS implementation, 802.3az EEE

**Bus Architecture** PCI Express 2.1 x4

**Data Transfer Mode** PCIe-based interface for active state operation

**Power Requirements** 1.4W typical at 2.5Gbps

**Network Transfer Mode** Multi-speed, full, and half-duplex 10BASE-T 100BASE-Tx 1000BASE-T **Network Transfer Rate** 

Management Capabilities WOL, PXE 2.1, UEFI, Power Management Protocol Offload (proxying), MAC

Power Management, Active State Power Management, ACPI

**Kit Contents** Intel® I226-T1® Adapter

HP 2.5GbE LAN Flex Port

Connector RJ45 (Single Port)

Cabling Copper twisted pair, Cat5e up to 100 meters

Controller Intel® 1225-V

Memory 4 Tx and 4 Rx Queues, Jumbo Frames up to 9KB and without TSN

10/100/1000Mbps and 2.5Gbps BASE-T **Data Rates Supported** 

Compliance IEEE 802.3, 802.3u (auto-negotiation), 802.3ab, 1588, 802.1AS-Rev,

802.1Qav, 802.1Qbu, 802.1Qbv, 802.3br, 802.3az

PCIe G2x1 **Bus Architecture** 

**Data Transfer Mode** PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

**Power Requirements** 2.2 Watts



#### Technical Specifications - Networking and Communications

**Network Transfer Mode** Automatic link configuration for speed duplex and flow control

**Network Transfer Rate** 2500BASE-T 1000BASE-T

> 100BASE-TX (Half-duplex supported) 10BASE-Te (Half-duplex supported)

Management Capabilities WOL, PXE, UEFI, Intel vPro® support with appropriate Intel Chipset, Error

Correcting Memory in packet buffers, UDP/TCP/IP Checksum Offload, SCTP

receive and transmit integrity offload

**Kit Contents** HP 2.5GbE LAN Flex Port Networking Interface Card

**HP 1GbE Fiber LC Single** Flex Port

Connector LC (Little Connector) Fiber (Single Port)

Cabling LC Fiber Cabling Controller AT-29M2

**Data Rates Supported** 1GBASE-SX **Bus Architecture** USB 3.1G1 **Power Requirements** Up to 3.3 Watts **Network Transfer Mode** 1GBASE-SX **Network Transfer Rate** 1GBASE-SX

Management Capabilities Wake on LAN, Digital Diagnostic Monitoring **Kit Contents** HP 1GbE Fiber LC Single Flex Port NIC

**HP Flex 1GbE Single Port** Connector NIC

RJ45 (Single Port)

Cabling 1GbE over Category 5e (or better) up to 100m

Controller Realtek RTL8153 **Data Rates Supported** 10/100/1000 Mbps **Bus Architecture** USB3.1G1. USB2

Requires 3.3V (integrated regulators for core Vdc) **Power Requirements** 

**Network Transfer Mode** Full-duplex; Half-duplex

**Network Transfer Rate** 10BASE-T (half-duplex) 10 Mbps

> 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities Wake on LAN, PXE, UEFI **Kit Contents HP 1GbE Single Flex Port** 

Intel® Ethernet 1350-T4V2 4-Port 1Gb NIC (After Market Option Only)

**Connector** 4x RJ-45 (Quad Port)

Cabling Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher)

for 1Gbps up to 100m

Controller Intel® I350

Memory Jumbo Frames up to 9.5KB, 8 Tx/Rx Queue pairs per port, Main Internal

memory is Error Code Correcting

**Data Rates Supported** 

10Mbps, 100Mbps, 1Gbps

Compliance IEEE 802.3 auto negotiation, 802.3, 802.3u, 802.3ab, 802.3x, 802.3z,

IEEE1588 protocol and 802.1AS implementation, 802.3az EEE

#### **Technical Specifications - Networking and Communications**

**Bus Architecture** PCI Express 2.1 x4

**Data Transfer Mode** PCIe-based interface for active state operation

**Power Requirements** 5W

Network Transfer ModeMulti-speed, full, and half-duplexNetwork Transfer Rate10BASE-T 100BASE-Tx 1000BASE-T

Management Capabilities WOL, PXE 2.1, UEFI, Power Management Protocol Offload (proxying), MAC

Power Management, Active State Power Management, VLAN, ACPI

**Kit Contents** 

Intel® Ethernet I350- T4V2 4-Port 1Gb NIC, installation instructions

Allies Telesis AT-2914SX/LC 1GB LC Fiber NIC **Connector** LC Fiber (Single Port)

Cabling 50/125 μm (core/cladding) multimode fiber optic cable up to 500m

62.5/125 µm (core/cladding) multimode fiber optic cable up to 220m

Memory Jumbo Frames up to 9.6KB

**Data Rates Supported** 

1000SX (1GbE Fiber at 850nm Wavelength)

Compliance

IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC), IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE

802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation)

RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI

**Bus Architecture** PCIe x1

**Data Transfer Mode** PCIe-based interface **Power Requirements** 1.5 Watts (typical)

**Network Transfer Rate** 1000SX only (1GbE Fiber at 850nm Wavelength)

Management Capabilities UEFI, Smart Load Balancing and failover, Link aggregation (IEEE802.3ad),

Generic trunking (FEC/GEC) / IEEE 802.3ad-draft static, VLAN Support

**Kit Contents** Allied Telesis AT-2914SX/LC 1GB LC Fiber NIC with low-profile bracket

attached and standard height bracket included

Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC **Connector** 2 x RJ-45 (Dual Port)

Cat3 (or higher) for 10Mbps

Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps up to 100m

Memory 17 Rx and 16 Tx queues

**Data Rates Supported** 10/100/1000 Mbps

Compliance IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC),

IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE 802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation), IEEE 802.3ab

(10/100/1000T)

RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI

**Bus Architecture** PCle 2x1

Data Transfer ModePCIe-based interfacePower Requirements2.4 Watts (typical)

Management Capabilities VLAN support, Link aggregation LACP, Link aggregation smart switch,

Failover, Smart Load Balancing (SLB), iSCSI boot support, Windows

Management Instrumentation (WMI), PXE 2.1, SNMP

**Kit Contents** Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC with low-profile bracket

#### **Technical Specifications - Networking and Communications**

attached and standard bracket included

MediaTek RZ616 Wi-Fi 6 + Connector Bluetooth® 5.3 wireless card Flex Port NIC with Internal Antenna

Controller

Connector Wireless N/A

Controller MediaTek RZ616

**Data Rates Supported** Wi-Fi 6 (2.4GHz/5GHz)

(20MHz, 40MHz, 80MHz, 160MHz)

Compliance IEEE 802.11 a/b/g/n/ac/ax

IEEE 802.11 d/e/h/i/j/k/mc/r/v/w

**Bus Architecture** PCIe G2.1 for WLAN, USB2.0 for BT

Capabilities WiFi:

MU-MIMO TX/RX, STBC, LDPC

Greenfield, mixed mode, legacy mode

Security support for WFA WPA/WPA2/WPA3 personal, WPS2.0

QoS support of WFA WMM, WMM PS

BT:

BT 2.1, 3.0, 5.3

Up to 7 BT links and 16BLE links SCO and eSCO link with retransmission

Packet Loss Concealment (PLC) for voice quality

AES128 and ECC256

**Kit Contents** MediaTek RZ616 Wi-Fi 6 + Bluetooth® 5.3 Flex Port NIC

**Installation Instructions** 

\* Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.

Intel® AX210 Wi-Fi 6E non-vPro + Bluetooth® 5.2 wireless card with External Antenna WLAN Connector Wireless Cabling N/A

Controller Intel® AX210

**Data Rates Supported** 

Wi-Fi 6e (2.4GHz/5GHz/6GHz)

Compliance

Wi-Fi Alliance\* Wi-Fi Alliance CERTIFIED 6, WiFi CERTIFIED a/b/g/n/ac, WMM, WMM-Power Save, WPA2, WPA3, Wi-Fi Direct, and Wi-Fi Agile

Multiband

IEEE WLAN Standard 802.11-2016, 802.11a, b, d, e, g, h, l, k, n, r, u, v, w, ac,

and ax, Bluetooth® 5.2

**Bus Architecture** PCIe G3x1 for WLAN, USB3.1G1 for BT

Management Capabilities Authentication Protocols: 802.1X EAP-TLS, EAP-TTLS/MSCHAPv2, PEAPv0 -

MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA')

Encryption: 128-bit AES-CCMP, 256-bit AES-GCMP

UEFI

**Kit Contents** Intel® AX210 Wi-Fi 6 + Bluetooth® 5.2 PCIe NIC

External Dipole Antenna Installation Instructions

\*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available

in countries where Wi-Fi 6E is supported.

Date of change:	Version History:		Description of change:
December 1, 2023	From v1 to v2	Changed	Other Hardware section



**Technical Specifications - Networking and Communications** 



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